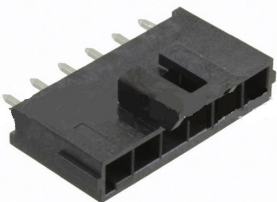


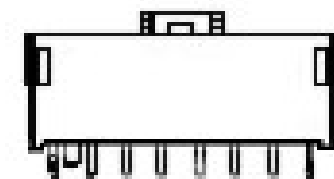
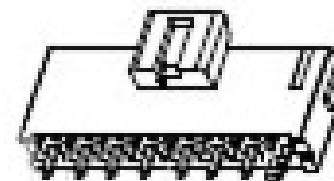
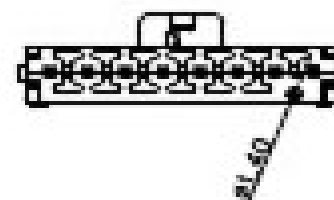
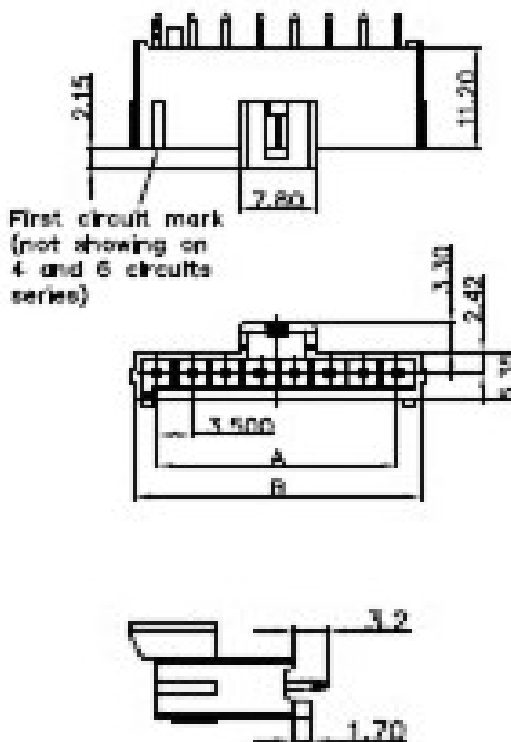
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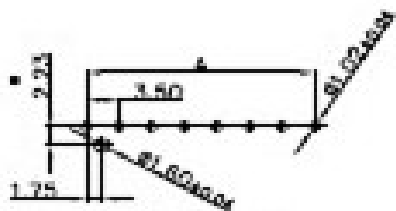
Technical Description

Curent Rating:	14A AC/DC at 16AWG
Contact Resistance:	15mΩ max.
Withstanding Voltage:	1800VAC/ DC
Insulation Resistance:	1000MΩ Min
Operating Temperature:	-.40°c to + 105°c
Contact Material:	Brass
Contact Plating:	Matte SN over Ni
Insulator Material:	LCP + 30%G.F UL94V-0
Available Pos.	2 to 8Pos

Drawing



PCB Layout (mm)



**Wire to Board Connector
(Wafer) Straight Pin with Look
Single Row**

Part No.: **T68H006**

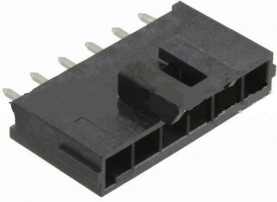
Customer:

DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	06.05.2024
APPD:	Schumi			FINISH	Jamy			Sheet No.	1 from 4

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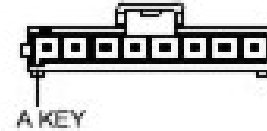
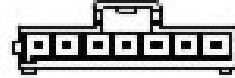
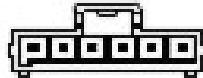
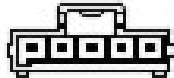
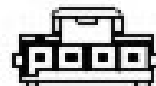
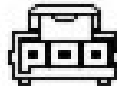
email: info@edcon-components.com

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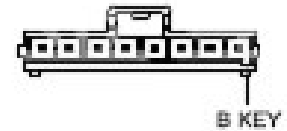


Dimension (mm)

No Pin	A	B	C
2	3,50	10,50	8,50
3	7,00	14,10	12,00
4	10,50	17,60	15,50
5	14,00	21,10	19,00
6	17,50	24,60	22,50
7	21,00	28,10	26,00
8	24,60	31,60	29,50
12	38,50	45,60	43,50



Key-code Left-Side



Key-code Right-Side

**Wire to Board Connector
(Wafer) Straight Pin with Look
Single Row**

Part No.: **T68H006**

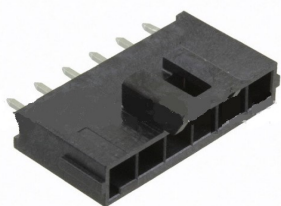
DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	06.05.2024
APPD:	Schumi			FINISH	Jamy		Sheet No.		2 from 4

Customer:

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Ordering Informations

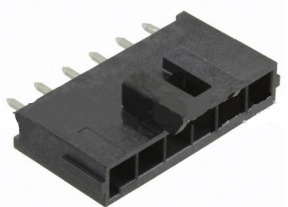
Serie	No. Of Position	Contact Plating	Contact Material	Color of Body	Key Code	Special Function	ROHS	Packing		
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T68H006	-	02	TN	BR	BK	L	N	R	BU	
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02= 2Pos.	TN= tinned	BR= Brass		L= Left Side	N= No Function	R= ROHS Conform	BU= Bulk-Ware
2 ~ 8Pos.			BK= Black	R= Right Side		N= NON ROHS Conform	TU= Tube Packing
							TC= Tube w. Cap Packing
							TR= Tape/Reel Packing w. Cap w. needed
	GD= Gold 1,5µ						IV= Individual Packing
	GE= Gold 3,0µ		NA= Nature				

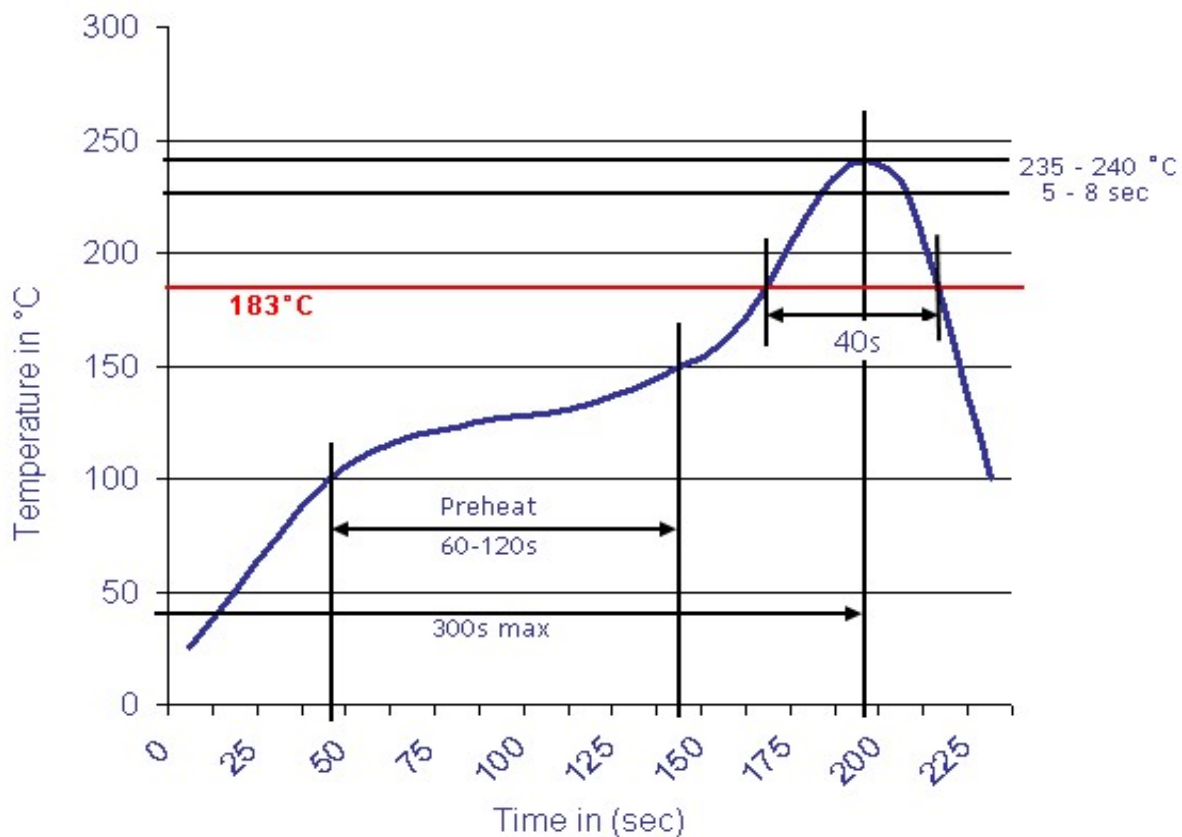
Wire to Board Connector (Wafer) Straight Pin with Look Single Row	
Part No.:	T68H006
Customer:	

DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	06.05.2024
APPD:	Schumi			FINISH	Jamy		Sheet No.		3 from 4



Soldering Profile Curve

Classification Reflow Profile (JEDEC J-STD-020C)



Wire to Board Connector (Wafer) Straight Pin with Lock Single Row	
Part No.:	T68H006
Customer:	

DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	06.05.2024
APPD:	Schumi			FINISH	Jamy		Sheet No.	4 from 4	